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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	RL78
Core Size	16-Bit
Speed	32MHz
Connectivity	CSI, I <sup>2</sup> C, LINbus, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	28
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	4K x 8
RAM Size	4K x 8
Voltage - Supply (Vcc/Vdd)	1.6V ~ 5.5V
Data Converters	A/D 9x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-WFQFN Exposed Pad
Supplier Device Package	40-HWQFN (6x6)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100eedna-u0">https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f100eedna-u0</a>

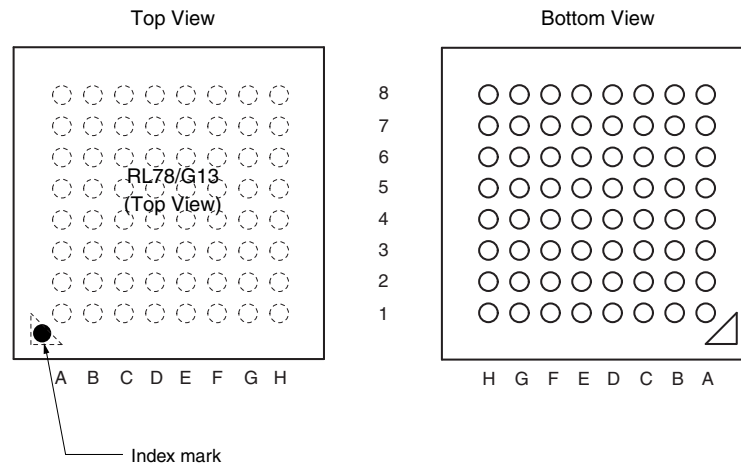
## 1.2 List of Part Numbers

Figure 1-1. Part Number, Memory Size, and Package of RL78/G13



- Notes**
1. Products only for "A: Consumer applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )", and "G: Industrial applications ( $T_A = -40$  to  $+105^\circ\text{C}$ )"
  2. Products only for "A: Consumer applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )", and "D: Industrial applications ( $T_A = -40$  to  $+85^\circ\text{C}$ )"

- 64-pin plastic VFBGA (4 × 4 mm, 0.4 mm pitch)



Pin No.	Name	Pin No.	Name	Pin No.	Name	Pin No.	Name
A1	P05/TI05/TO05	C1	P51/INTP2/SO11	E1	P13/TxD2/SO20/(SDAA0)/(TI04)/(TO04)	G1	P146
A2	P30/INTP3/RTC1HZ/SCK11/SCL11	C2	P71/KR1/SI21/SDA21	E2	P14/RxD2/SI20/SDA20/(SCLA0)/(TI03)/(TO03)	G2	P25/ANI5
A3	P70/KR0/SCK21/SCL21	C3	P74/KR4/INTP8/SI01/SDA01	E3	P15/SCK20/SCL20/(TI02)/(TO02)	G3	P24/ANI4
A4	P75/KR5/INTP9/SCK01/SCL01	C4	P52/(INTP10)	E4	P16/TI01/TO01/INTP5/(SI00)/(RxD0)	G4	P22/ANI2
A5	P77/KR7/INTP11/(TxD2)	C5	P53/(INTP11)	E5	P03/ANI16/SI10/RxD1/SDA10	G5	P130
A6	P61/SDAA0	C6	P63	E6	P41/TI07/TO07	G6	P02/ANI17/SO10/TxD1
A7	P60/SCLA0	C7	V <sub>SS</sub>	E7	RESET	G7	P00/TI00
A8	EV <sub>DD0</sub>	C8	P121/X1	E8	P137/INTP0	G8	P124/XT2/EXCLKS
B1	P50/INTP1/SI11/SDA11	D1	P55/(PCLBUZ1)/(SCK00)	F1	P10/SCK00/SCL00/(TI07)/(TO07)	H1	P147/ANI18
B2	P72/KR2/SO21	D2	P06/TI06/TO06	F2	P11/SI00/RxD0/TOOLRxD/SDA00/(TI06)/(TO06)	H2	P27/ANI7
B3	P73/KR3/SO01	D3	P17/TI02/TO02/(SO00)/(TxD0)	F3	P12/SO00/TxD0/TOOLTxD/(INTP5)/(TI05)/(TO05)	H3	P26/ANI6
B4	P76/KR6/INTP10/(RxD2)	D4	P54	F4	P21/ANI1/AV <sub>REFM</sub>	H4	P23/ANI3
B5	P31/TI03/TO03/INTP4/(PCLBUZ0)	D5	P42/TI04/TO04	F5	P04/SCK10/SCL10	H5	P20/ANI0/AV <sub>REFP</sub>
B6	P62	D6	P40/TOOL0	F6	P43	H6	P141/PCLBUZ1/INTP7
B7	V <sub>DD</sub>	D7	REGC	F7	P01/TO00	H7	P140/PCLBUZ0/INTP6
B8	EV <sub>SS0</sub>	D8	P122/X2/EXCLK	F8	P123/XT1	H8	P120/ANI19

**Cautions** 1. Make EV<sub>SS0</sub> pin the same potential as V<sub>SS</sub> pin.

2. Make V<sub>DD</sub> pin the potential that is higher than EV<sub>DD0</sub> pin.

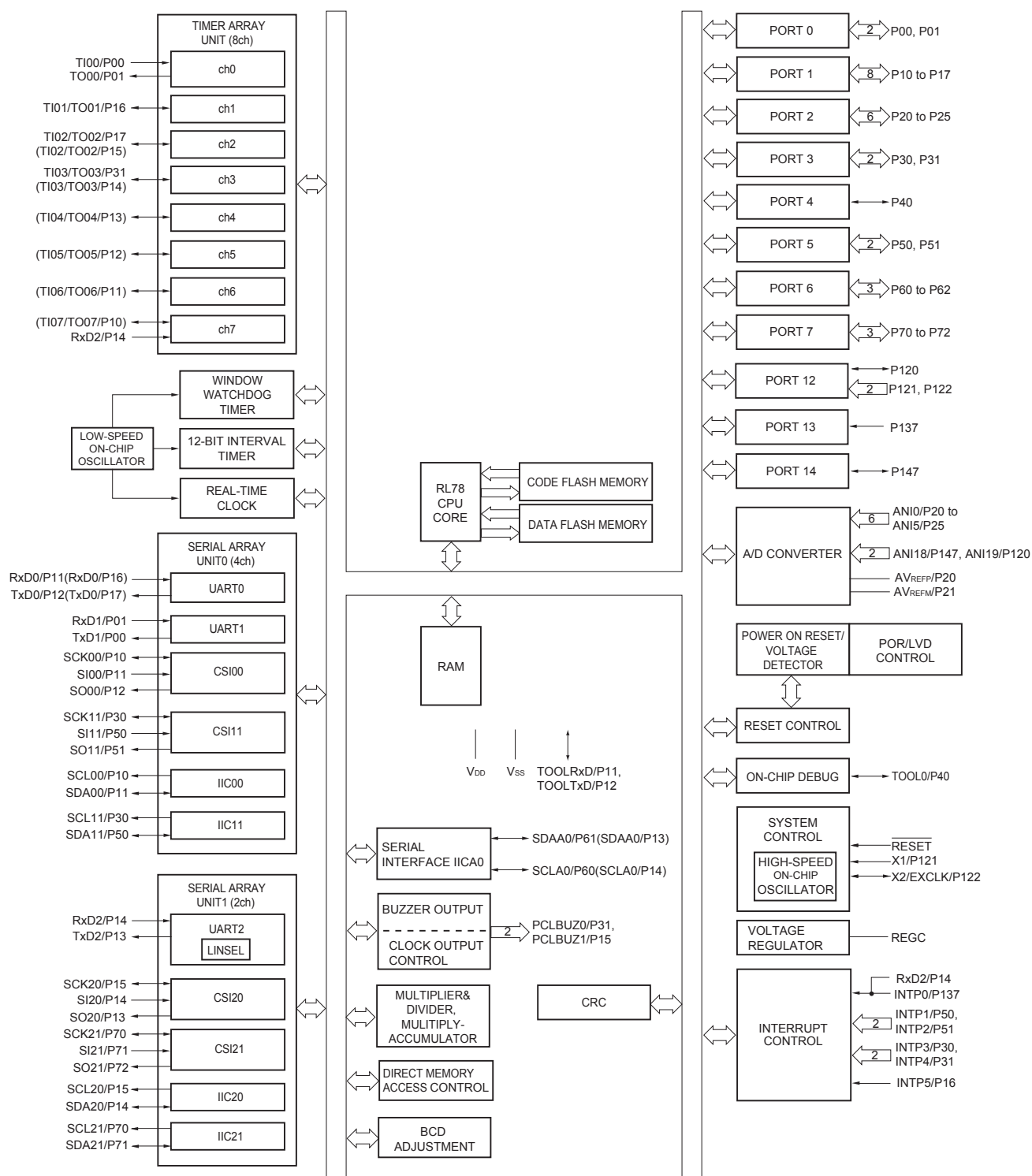
3. Connect the REGC pin to V<sub>SS</sub> via a capacitor (0.47 to 1  $\mu$ F).

**Remarks** 1. For pin identification, see 1.4 Pin Identification.

2. When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the V<sub>DD</sub> and EV<sub>DD0</sub> pins and connect the V<sub>SS</sub> and EV<sub>SS0</sub> pins to separate ground lines.

3. Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

## 1.5.6 36-pin products



**Remark** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

2. The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).
3. When setting to PIOR = 1

(2/2)

Item		40-pin		44-pin		48-pin		52-pin		64-pin	
		R5F100Ex	R5F101Ex	R5F100Fx	R5F101Fx	R5F100Gx	R5F101Gx	R5F100Lx	R5F101Lx	R5F100Lx	R5F101Lx
Clock output/buzzer output		2		2		2		2		2	
		<ul style="list-style-type: none"><li>2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: f<sub>MAIN</sub> = 20 MHz operation)</li><li>256 Hz, 512 Hz, 1.024 kHz, 2.048 kHz, 4.096 kHz, 8.192 kHz, 16.384 kHz, 32.768 kHz (Subsystem clock: f<sub>SUB</sub> = 32.768 kHz operation)</li></ul>									
8/10-bit resolution A/D converter		9 channels		10 channels		10 channels		12 channels		12 channels	
Serial interface		[40-pin, 44-pin products] <ul style="list-style-type: none"><li>CSI: 1 channel/simplified I<sup>2</sup>C: 1 channel/UART: 1 channel</li><li>CSI: 1 channel/simplified I<sup>2</sup>C: 1 channel/UART: 1 channel</li><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART (UART supporting LIN-bus): 1 channel</li></ul> [48-pin, 52-pin products] <ul style="list-style-type: none"><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART: 1 channel</li><li>CSI: 1 channel/simplified I<sup>2</sup>C: 1 channel/UART: 1 channel</li><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART (UART supporting LIN-bus): 1 channel</li></ul> [64-pin products] <ul style="list-style-type: none"><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART: 1 channel</li><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART: 1 channel</li><li>CSI: 2 channels/simplified I<sup>2</sup>C: 2 channels/UART (UART supporting LIN-bus): 1 channel</li></ul>									
		I <sup>2</sup> C bus	1 channel		1 channel		1 channel		1 channel		1 channel
Multiplier and divider/multiply-accumulator		<ul style="list-style-type: none"><li>16 bits × 16 bits = 32 bits (Unsigned or signed)</li><li>32 bits ÷ 32 bits = 32 bits (Unsigned)</li><li>16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed)</li></ul>									
DMA controller		2 channels									
Vectored interrupt sources	Internal	27		27		27		27		27	
	External	7		7		10		12		13	
Key interrupt		4		4		6		8		8	
Reset		<ul style="list-style-type: none"><li>Reset by RESET pin</li><li>Internal reset by watchdog timer</li><li>Internal reset by power-on-reset</li><li>Internal reset by voltage detector</li><li>Internal reset by illegal instruction execution <sup>Note</sup></li><li>Internal reset by RAM parity error</li><li>Internal reset by illegal-memory access</li></ul>									
Power-on-reset circuit		<ul style="list-style-type: none"><li>Power-on-reset: 1.51 V (TYP.)</li><li>Power-down-reset: 1.50 V (TYP.)</li></ul>									
Voltage detector		<ul style="list-style-type: none"><li>Rising edge : 1.67 V to 4.06 V (14 stages)</li><li>Falling edge : 1.63 V to 3.98 V (14 stages)</li></ul>									
On-chip debug function		Provided									
Power supply voltage		V <sub>DD</sub> = 1.6 to 5.5 V (T <sub>A</sub> = -40 to +85°C) V <sub>DD</sub> = 2.4 to 5.5 V (T <sub>A</sub> = -40 to +105°C)									
Operating ambient temperature		T <sub>A</sub> = 40 to +85°C (A: Consumer applications, D: Industrial applications) T <sub>A</sub> = 40 to +105°C (G: Industrial applications)									

**Note** The illegal instruction is generated when instruction code FFH is executed.

Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

&lt;R&gt;

(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V) (2/5)

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Output current, I <sub>OL</sub> <sup>Note 1</sup>	I <sub>OL1</sub>	Per pin for P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147			20.0 <sup>Note 2</sup>	mA
		Per pin for P60 to P63			15.0 <sup>Note 2</sup>	mA
		Total of P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145 (When duty ≤ 70% <sup>Note 3</sup> )	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		70.0	mA
			2.7 V ≤ EV <sub>DD0</sub> < 4.0 V		15.0	mA
			1.8 V ≤ EV <sub>DD0</sub> < 2.7 V		9.0	mA
			1.6 V ≤ EV <sub>DD0</sub> < 1.8 V		4.5	mA
		Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147 (When duty ≤ 70% <sup>Note 3</sup> )	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		80.0	mA
			2.7 V ≤ EV <sub>DD0</sub> < 4.0 V		35.0	mA
			1.8 V ≤ EV <sub>DD0</sub> < 2.7 V		20.0	mA
			1.6 V ≤ EV <sub>DD0</sub> < 1.8 V		10.0	mA
		Total of all pins (When duty ≤ 70% <sup>Note 3</sup> )			150.0	mA
	I <sub>OL2</sub>	Per pin for P20 to P27, P150 to P156			0.4 <sup>Note 2</sup>	mA
		Total of all pins (When duty ≤ 70% <sup>Note 3</sup> )	1.6 V ≤ V <sub>DD</sub> ≤ 5.5 V		5.0	mA

- Notes**
- Value of current at which the device operation is guaranteed even if the current flows from an output pin to the EV<sub>SS0</sub>, EV<sub>SS1</sub> and V<sub>SS</sub> pin.
  - However, do not exceed the total current value.
  - Specification under conditions where the duty factor ≤ 70%.  
The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).
    - Total output current of pins = (I<sub>OL</sub> × 0.7)/(n × 0.01)

<Example> Where n = 80% and I<sub>OL</sub> = 10.0 mA

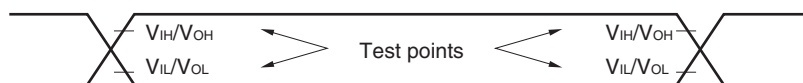
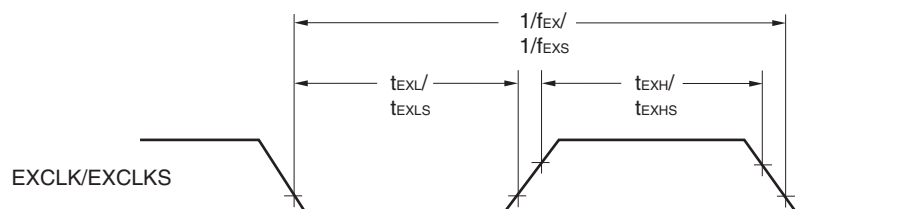
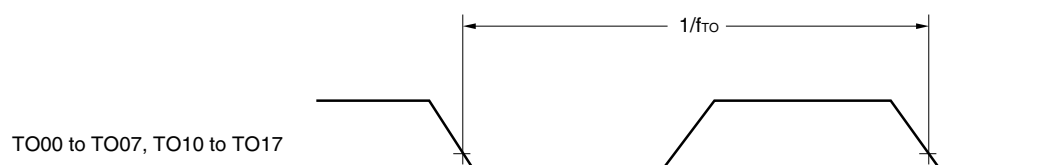
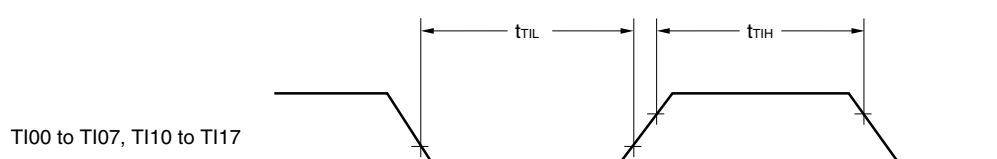
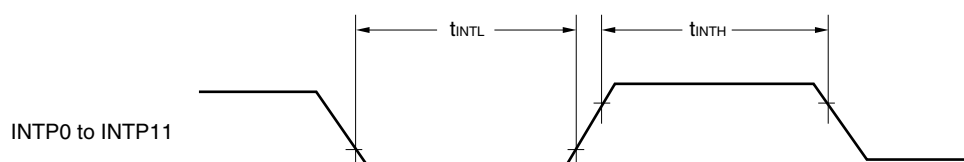
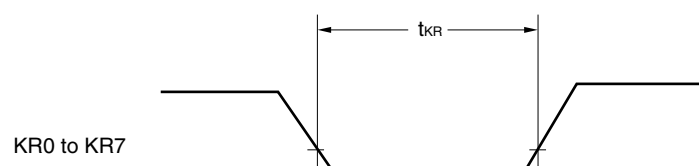
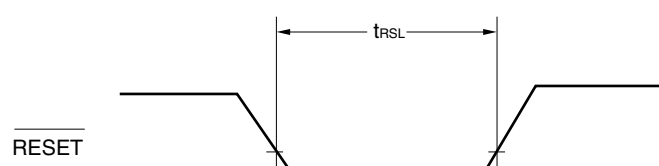
Total output current of pins = (10.0 × 0.7)/(80 × 0.01) ≅ 8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

- Notes**
1. Total current flowing into V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, including the input leakage current flowing when the level of the input pin is fixed to V<sub>DD</sub>, EV<sub>DD0</sub>, and EV<sub>DD1</sub>, or V<sub>SS</sub>, EV<sub>SS0</sub>, and EV<sub>SS1</sub>. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.
  2. When high-speed on-chip oscillator and subsystem clock are stopped.
  3. When high-speed system clock and subsystem clock are stopped.
  4. When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the 12-bit interval timer and watchdog timer.
  5. Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.
    - HS (high-speed main) mode:  $2.7\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 32 MHz
    - $2.4\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 16 MHz
    - LS (low-speed main) mode:  $1.8\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 8 MHz
    - LV (low-voltage main) mode:  $1.6\text{ V} \leq V_{DD} \leq 5.5\text{ V}$  @ 1 MHz to 4 MHz

- Remarks**
1. f<sub>MX</sub>: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)
  2. f<sub>IH</sub>: High-speed on-chip oscillator clock frequency
  3. f<sub>SUB</sub>: Subsystem clock frequency (XT1 clock oscillation frequency)
  4. Except subsystem clock operation, temperature condition of the TYP. value is T<sub>A</sub> = 25°C

**AC Timing Test Points****External System Clock Timing****TI/TO Timing****Interrupt Request Input Timing****Key Interrupt Input Timing****RESET Input Timing**



**(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (CSI mode) (master mode, SCKp... internal clock output)**  
**(3/3)**

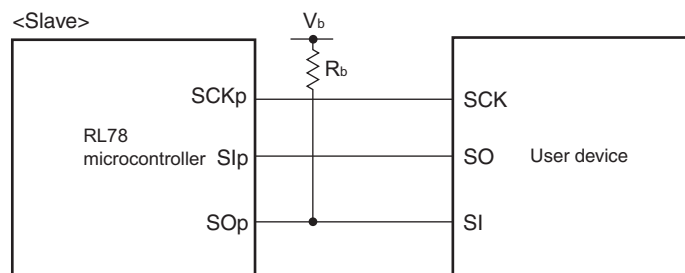
(T<sub>A</sub> = -40 to +85°C, 1.8 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
			MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
Slp setup time (to SCKp↓) <sup>Note 1</sup>	t <sub>SIK1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	44		110		110		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	44		110		110		ns
		1.8 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	110		110		110		ns
Slp hold time (from SCKp↓) <sup>Note 1</sup>	t <sub>KSH1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ	19		19		19		ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ	19		19		19		ns
		1.8 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ	19		19		19		ns
Delay time from SCKp↑ to SOp output <sup>Note 1</sup>	t <sub>KSO1</sub>	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 1.4 kΩ		25		25		25	ns
		2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V, C <sub>b</sub> = 30 pF, R <sub>b</sub> = 2.7 kΩ		25		25		25	ns
		1.8 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V <sup>Note 2</sup> , C <sub>b</sub> = 30 pF, R <sub>b</sub> = 5.5 kΩ		25		25		25	ns

- Notes**
1. When DAP<sub>mn</sub> = 0 and CKP<sub>mn</sub> = 1, or DAP<sub>mn</sub> = 1 and CKP<sub>mn</sub> = 0.
  2. Use it with EV<sub>DD0</sub> ≥ V<sub>b</sub>.

**Caution** Select the TTL input buffer for the Slp pin and the N-ch open drain output (V<sub>DD</sub> tolerance (When 20- to 52-pin products)/EV<sub>DD</sub> tolerance (When 64- to 128-pin products)) mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For V<sub>IH</sub> and V<sub>IL</sub>, see the DC characteristics with TTL input buffer selected.

(Remarks are listed on the next page.)

**CSI mode connection diagram (during communication at different potential)**

- Remarks**
1.  $R_b[\Omega]$ : Communication line (SO<sub>p</sub>) pull-up resistance,  $C_b[F]$ : Communication line (SO<sub>p</sub>) load capacitance,  $V_b[V]$ : Communication line voltage
  2. p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)
  3.  $f_{MCK}$ : Serial array unit operation clock frequency  
(Operation clock to be set by the CKS<sub>mn</sub> bit of serial mode register mn (SMR<sub>mn</sub>).  
m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13))
  4. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential.  
Use other CSI for communication at different potential.

## 2.5.2 Serial interface IICA

(1) I<sup>2</sup>C standard mode(T<sub>A</sub> = -40 to +85°C, 1.6 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions		HS (high-speed main) Mode		LS (low-speed main) Mode		LV (low-voltage main) Mode		Unit
				MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	
SCLA0 clock frequency	f <sub>SCL</sub>	Standard mode: f <sub>CLK</sub> ≥ 1 MHz	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	100	0	100	0	100	kHz
			1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		0	100	0	100	kHz
Setup time of restart condition	t <sub>SU:STA</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.7		4.7		μs	
Hold time <sup>Note 1</sup>	t <sub>HD:STA</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.0		4.0		μs	
Hold time when SCLA0 = “L”	t <sub>LOW</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.7		4.7		μs	
Hold time when SCLA0 = “H”	t <sub>HIGH</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.0		4.0		μs	
Data setup time (reception)	t <sub>SU:DAT</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	250		250		250		ns	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	250		250		250		ns	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	250		250		250		ns	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		250		250		ns	
Data hold time (transmission) <sup>Note 2</sup>	t <sub>HD:DAT</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	0	3.45	0	3.45	0	3.45	μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		0	3.45	0	3.45	μs	
Setup time of stop condition	t <sub>SU:STO</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.0		4.0		4.0		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.0		4.0		μs	
Bus-free time	t <sub>BUF</sub>	2.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.8 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.7 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	4.7		4.7		4.7		μs	
		1.6 V ≤ EV <sub>DD0</sub> ≤ 5.5 V	—		4.7		4.7		μs	

(Notes, Caution and Remark are listed on the next page.)

**Absolute Maximum Ratings ( $T_A = 25^{\circ}\text{C}$ ) (2/2)**

Parameter	Symbols	Conditions		Ratings	Unit
Output current, high	I <sub>OH1</sub>	Per pin	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	−40	mA
		Total of all pins −170 mA	P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145	−70	mA
			P05, P06, P10 to P17, P30, P31, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147	−100	mA
	I <sub>OH2</sub>	Per pin	P20 to P27, P150 to P156	−0.5	mA
		Total of all pins		−2	mA
	Output current, low	I <sub>OL1</sub>	Per pin	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147	40
Total of all pins 170 mA			P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145	70	mA
			P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147	100	mA
I <sub>OL2</sub>		Per pin	P20 to P27, P150 to P156	1	mA
		Total of all pins		5	mA
Operating ambient temperature		T <sub>A</sub>	In normal operation mode		−40 to +105
	In flash memory programming mode				
Storage temperature	T <sub>stg</sub>			−65 to +150	°C

**Caution** Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is, the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq \text{EV}_{\text{DD0}} = \text{EV}_{\text{DD1}} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$ ,  $\text{V}_{\text{SS}} = \text{EV}_{\text{SS0}} = \text{EV}_{\text{SS1}} = 0\text{ V}$ ) (3/5)**

Items	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Input voltage, high	$\text{V}_{\text{IH1}}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147	Normal input buffer	$0.8\text{EV}_{\text{DD0}}$	$\text{EV}_{\text{DD0}}$	V
	$\text{V}_{\text{IH2}}$	P01, P03, P04, P10, P11, P13 to P17, P43, P44, P53 to P55, P80, P81, P142, P143	TTL input buffer $4.0\text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5\text{ V}$	2.2	$\text{EV}_{\text{DD0}}$	V
			TTL input buffer $3.3\text{ V} \leq \text{EV}_{\text{DD0}} < 4.0\text{ V}$	2.0	$\text{EV}_{\text{DD0}}$	V
			TTL input buffer $2.4\text{ V} \leq \text{EV}_{\text{DD0}} < 3.3\text{ V}$	1.5	$\text{EV}_{\text{DD0}}$	V
	$\text{V}_{\text{IH3}}$	P20 to P27, P150 to P156	$0.7\text{V}_{\text{DD}}$		$\text{V}_{\text{DD}}$	V
	$\text{V}_{\text{IH4}}$	P60 to P63	$0.7\text{EV}_{\text{DD0}}$		6.0	V
	$\text{V}_{\text{IH5}}$	P121 to P124, P137, EXCLK, EXCLKS, $\overline{\text{RESET}}$	$0.8\text{V}_{\text{DD}}$		$\text{V}_{\text{DD}}$	V
Input voltage, low	$\text{V}_{\text{IL1}}$	P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P140 to P147	Normal input buffer	0	$0.2\text{EV}_{\text{DD0}}$	V
	$\text{V}_{\text{IL2}}$	P01, P03, P04, P10, P11, P13 to P17, P43, P44, P53 to P55, P80, P81, P142, P143	TTL input buffer $4.0\text{ V} \leq \text{EV}_{\text{DD0}} \leq 5.5\text{ V}$	0	0.8	V
			TTL input buffer $3.3\text{ V} \leq \text{EV}_{\text{DD0}} < 4.0\text{ V}$	0	0.5	V
			TTL input buffer $2.4\text{ V} \leq \text{EV}_{\text{DD0}} < 3.3\text{ V}$	0	0.32	V
	$\text{V}_{\text{IL3}}$	P20 to P27, P150 to P156	0		$0.3\text{V}_{\text{DD}}$	V
	$\text{V}_{\text{IL4}}$	P60 to P63	0		$0.3\text{EV}_{\text{DD0}}$	V
	$\text{V}_{\text{IL5}}$	P121 to P124, P137, EXCLK, EXCLKS, $\overline{\text{RESET}}$	0		$0.2\text{V}_{\text{DD}}$	V

**Caution** The maximum value of  $\text{V}_{\text{IH}}$  of pins P00, P02 to P04, P10 to P15, P17, P43 to P45, P50, P52 to P55, P71, P74, P80 to P82, P96, and P142 to P144 is  $\text{EV}_{\text{DD0}}$ , even in the N-ch open-drain mode.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

**(3) Peripheral Functions (Common to all products)****( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$ ,  $\text{V}_{\text{SS}} = \text{EV}_{\text{SS}0} = \text{EV}_{\text{SS}1} = 0\text{ V}$ )**

Parameter	Symbol	Conditions		MIN.	TYP.	MAX.	Unit
Low-speed on-chip oscillator operating current	$I_{\text{FIL}}$ Note 1				0.20		$\mu\text{A}$
RTC operating current	$I_{\text{RTC}}$ Notes 1, 2, 3				0.02		$\mu\text{A}$
12-bit interval timer operating current	$I_{\text{IT}}$ Notes 1, 2, 4				0.02		$\mu\text{A}$
Watchdog timer operating current	$I_{\text{WDT}}$ Notes 1, 2, 5	$f_{\text{IL}} = 15\text{ kHz}$			0.22		$\mu\text{A}$
A/D converter operating current	$I_{\text{ADC}}$ Notes 1, 6	When conversion at maximum speed	Normal mode, $\text{AV}_{\text{REFP}} = \text{V}_{\text{DD}} = 5.0\text{ V}$		1.3	1.7	$\text{mA}$
			Low voltage mode, $\text{AV}_{\text{REFP}} = \text{V}_{\text{DD}} = 3.0\text{ V}$		0.5	0.7	$\text{mA}$
A/D converter reference voltage current	$I_{\text{ADREF}}$ Note 1				75.0		$\mu\text{A}$
Temperature sensor operating current	$I_{\text{TMPS}}$ Note 1				75.0		$\mu\text{A}$
LVD operating current	$I_{\text{LVD}}$ Notes 1, 7				0.08		$\mu\text{A}$
Self programming operating current	$I_{\text{FSP}}$ Notes 1, 9				2.50	12.20	$\text{mA}$
BGO operating current	$I_{\text{BGO}}$ Notes 1, 8				2.50	12.20	$\text{mA}$
SNOOZE operating current	$I_{\text{SNOZ}}$ Note 1	ADC operation	The mode is performed <sup>Note 10</sup>		0.50	1.10	$\text{mA}$
			The A/D conversion operations are performed, Low voltage mode, $\text{AV}_{\text{REFP}} = \text{V}_{\text{DD}} = 3.0\text{ V}$		1.20	2.04	$\text{mA}$
		CSI/UART operation			0.70	1.54	$\text{mA}$

**Notes** 1. Current flowing to the  $\text{V}_{\text{DD}}$ .

2. When high speed on-chip oscillator and high-speed system clock are stopped.

3. Current flowing only to the real-time clock (RTC) (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either  $I_{\text{DD}1}$  or  $I_{\text{DD}2}$ , and  $I_{\text{RTC}}$ , when the real-time clock operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{\text{FIL}}$  should be added.  $I_{\text{DD}2}$  subsystem clock operation includes the operational current of the real-time clock.4. Current flowing only to the 12-bit interval timer (excluding the operating current of the low-speed on-chip oscillator and the XT1 oscillator). The supply current of the RL78 microcontrollers is the sum of the values of either  $I_{\text{DD}1}$  or  $I_{\text{DD}2}$ , and  $I_{\text{IT}}$ , when the 12-bit interval timer operates in operation mode or HALT mode. When the low-speed on-chip oscillator is selected,  $I_{\text{FIL}}$  should be added.5. Current flowing only to the watchdog timer (including the operating current of the low-speed on-chip oscillator). The supply current of the RL78 is the sum of  $I_{\text{DD}1}$ ,  $I_{\text{DD}2}$  or  $I_{\text{DD}3}$  and  $I_{\text{WDT}}$  when the watchdog timer operates.

## 3.4 AC Characteristics

(T<sub>A</sub> =  $-40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq \text{EV}_{\text{DD}0} = \text{EV}_{\text{DD}1} \leq \text{V}_{\text{DD}} \leq 5.5\text{ V}$ ,  $\text{V}_{\text{SS}} = \text{EV}_{\text{SS}0} = \text{EV}_{\text{SS}1} = 0\text{ V}$ )

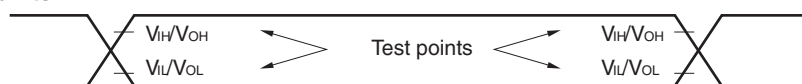
Items	Symbol	Conditions			MIN.	TYP.	MAX.	Unit
Instruction cycle (minimum instruction execution time)	T <sub>cy</sub>	Main system clock (f <sub>MAIN</sub> ) operation	HS (high-speed main) mode	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0.03125		1	μs
				2.4 V ≤ V <sub>DD</sub> < 2.7 V	0.0625		1	μs
		Subsystem clock (f <sub>SUB</sub> ) operation		2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V	28.5	30.5	31.3	μs
		In the self programming mode	HS (high-speed main) mode	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V	0.03125		1	μs
				2.4 V ≤ V <sub>DD</sub> < 2.7 V	0.0625		1	μs
External system clock frequency	f <sub>EX</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V			1.0		20.0	MHz
		2.4 V ≤ V <sub>DD</sub> < 2.7 V			1.0		16.0	MHz
	f <sub>EXS</sub>				32		35	kHz
External system clock input high-level width, low-level width	t <sub>EXH</sub> , t <sub>EXL</sub>	2.7 V ≤ V <sub>DD</sub> ≤ 5.5 V			24			ns
		2.4 V ≤ V <sub>DD</sub> < 2.7 V			30			ns
	t <sub>EXHS</sub> , t <sub>EXLS</sub>				13.7			μs
Ti00 to Ti07, Ti10 to Ti17 input high-level width, low-level width	t <sub>TIH</sub> , t <sub>TIL</sub>				1/f <sub>MCK</sub> +10			ns <sup>Note</sup>
TO00 to TO07, TO10 to TO17 output frequency	f <sub>TO</sub>	HS (high-speed main) mode	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V				16	MHz
			2.7 V ≤ EV <sub>DD0</sub> < 4.0 V				8	MHz
			2.4 V ≤ EV <sub>DD0</sub> < 2.7 V				4	MHz
PCLBUZ0, PCLBUZ1 output frequency	f <sub>PCL</sub>	HS (high-speed main) mode	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V				16	MHz
			2.7 V ≤ EV <sub>DD0</sub> < 4.0 V				8	MHz
			2.4 V ≤ EV <sub>DD0</sub> < 2.7 V				4	MHz
Interrupt input high-level width, low-level width	t <sub>INTH</sub> , t <sub>INTL</sub>	INTP0	2.4 V ≤ V <sub>DD</sub> ≤ 5.5 V		1			μs
		INTP1 to INTP11	2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		1			μs
Key interrupt input low-level width	t <sub>KR</sub>	KR0 to KR7	2.4 V ≤ EV <sub>DD0</sub> ≤ 5.5 V		250			ns
RESET low-level width	t <sub>RSL</sub>				10			μs

**Note** The following conditions are required for low voltage interface when  $\text{EV}_{\text{DD}0} < \text{V}_{\text{DD}}$   
 $2.4\text{ V} \leq \text{EV}_{\text{DD}0} < 2.7\text{ V}$  : MIN. 125 ns

**Remark** f<sub>MCK</sub>: Timer array unit operation clock frequency  
 (Operation clock to be set by the CKSmn0, CKSmn1 bits of timer mode register mn (TMRmn).  
 m: Unit number (m = 0, 1), n: Channel number (n = 0 to 7))

### 3.5 Peripheral Functions Characteristics

#### AC Timing Test Points



#### 3.5.1 Serial array unit

##### (1) During communication at same potential (UART mode)

( $T_A = -40$  to  $+105^\circ\text{C}$ ,  $2.4\text{ V} \leq E_{VDD0} = E_{VDD1} \leq V_{DD} \leq 5.5\text{ V}$ ,  $V_{SS} = E_{VSS0} = E_{VSS1} = 0\text{ V}$ )

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
Transfer rate <sup>Note 1</sup>		Theoretical value of the maximum transfer rate $f_{CLK} = 32\text{ MHz}$ , $f_{MCK} = f_{CLK}$		$f_{MCK}/12$ <sup>Note 2</sup>	bps
				2.6	Mbps

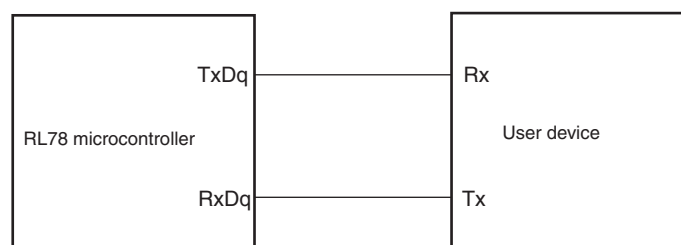
**Notes 1.** Transfer rate in the SNOOZE mode is 4800 bps only.

**2.** The following conditions are required for low voltage interface when  $E_{VDD0} < V_{DD}$ .

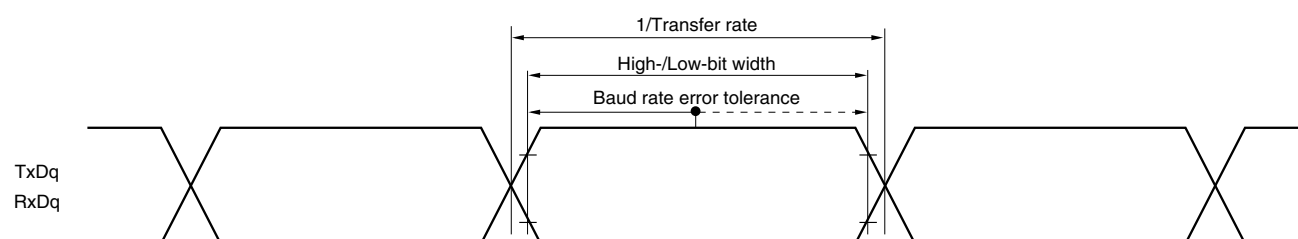
$2.4\text{ V} \leq E_{VDD0} < 2.7\text{ V}$  : MAX. 1.3 Mbps

**Caution** Select the normal input buffer for the RxDq pin and the normal output mode for the TxDq pin by using port input mode register g (PIMg) and port output mode register g (POMg).

#### UART mode connection diagram (during communication at same potential)



#### UART mode bit width (during communication at same potential) (reference)



**Remarks 1.** q: UART number (q = 0 to 3), g: PIM and POM number (g = 0, 1, 8, 14)

**2.**  $f_{MCK}$ : Serial array unit operation clock frequency

(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00 to 03, 10 to 13))



## (5) Communication at different potential (1.8 V, 2.5 V, 3 V) (UART mode) (2/2)

(T<sub>A</sub> = -40 to +105°C, 2.4 V ≤ EV<sub>DD0</sub> = EV<sub>DD1</sub> ≤ V<sub>DD</sub> ≤ 5.5 V, V<sub>SS</sub> = EV<sub>SS0</sub> = EV<sub>SS1</sub> = 0 V)

Parameter	Symbol	Conditions	HS (high-speed main) Mode		Unit
			MIN.	MAX.	
Transfer rate		Transmission	4.0 V ≤ EV <sub>DD0</sub> ≤ 5.5 V, 2.7 V ≤ V <sub>b</sub> ≤ 4.0 V		
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 1.4 kΩ, V <sub>b</sub> = 2.7 V		
				<b>Note 1</b>	bps
				2.6 <sup>Note 2</sup>	Mbps
			2.7 V ≤ EV <sub>DD0</sub> < 4.0 V, 2.3 V ≤ V <sub>b</sub> ≤ 2.7 V		
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 2.7 kΩ, V <sub>b</sub> = 2.3 V		
					<b>Note 3</b>
					1.2 <sup>Note 4</sup>
					Mbps
			2.4 V ≤ EV <sub>DD0</sub> < 3.3 V, 1.6 V ≤ V <sub>b</sub> ≤ 2.0 V		
			Theoretical value of the maximum transfer rate C <sub>b</sub> = 50 pF, R <sub>b</sub> = 5.5 kΩ, V <sub>b</sub> = 1.6 V		
					<b>Note 5</b>
					0.43 <sup>Note 6</sup>

**Notes 1.** The smaller maximum transfer rate derived by using f<sub>MCK</sub>/12 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 4.0 V ≤ EV<sub>DD0</sub> ≤ 5.5 V and 2.7 V ≤ V<sub>b</sub> ≤ 4.0 V

$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.2}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

\* This value is the theoretical value of the relative difference between the transmission and reception sides.

- This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 1 above to calculate the maximum transfer rate under conditions of the customer.
- The smaller maximum transfer rate derived by using f<sub>MCK</sub>/12 or the following expression is the valid maximum transfer rate.

Expression for calculating the transfer rate when 2.7 V ≤ EV<sub>DD0</sub> < 4.0 V and 2.4 V ≤ V<sub>b</sub> ≤ 2.7 V

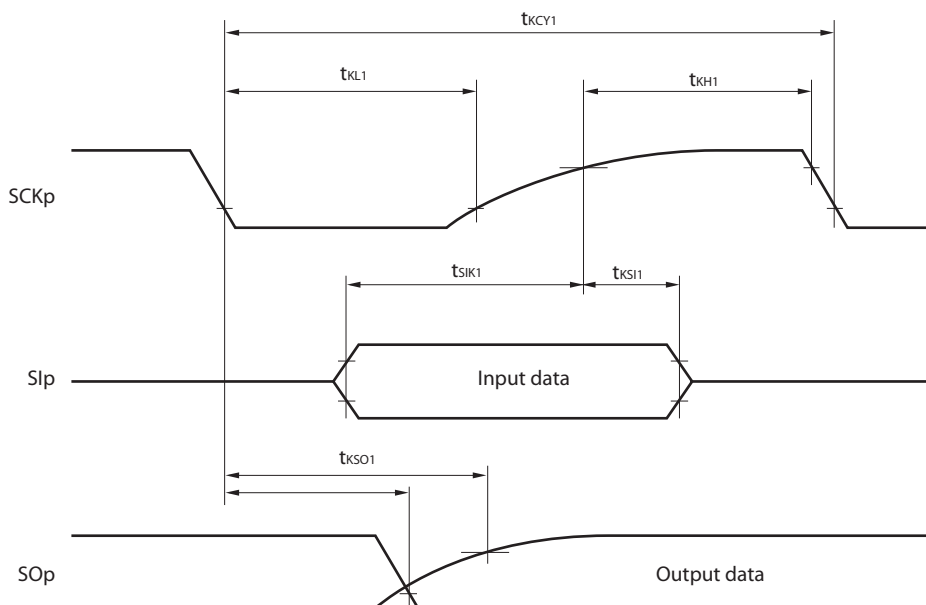
$$\text{Maximum transfer rate} = \frac{1}{\{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\} \times 3} \text{ [bps]}$$

$$\text{Baud rate error (theoretical value)} = \frac{\frac{1}{\text{Transfer rate} \times 2} - \{-C_b \times R_b \times \ln(1 - \frac{2.0}{V_b})\}}{(\frac{1}{\text{Transfer rate}}) \times \text{Number of transferred bits}} \times 100 \text{ [%]}$$

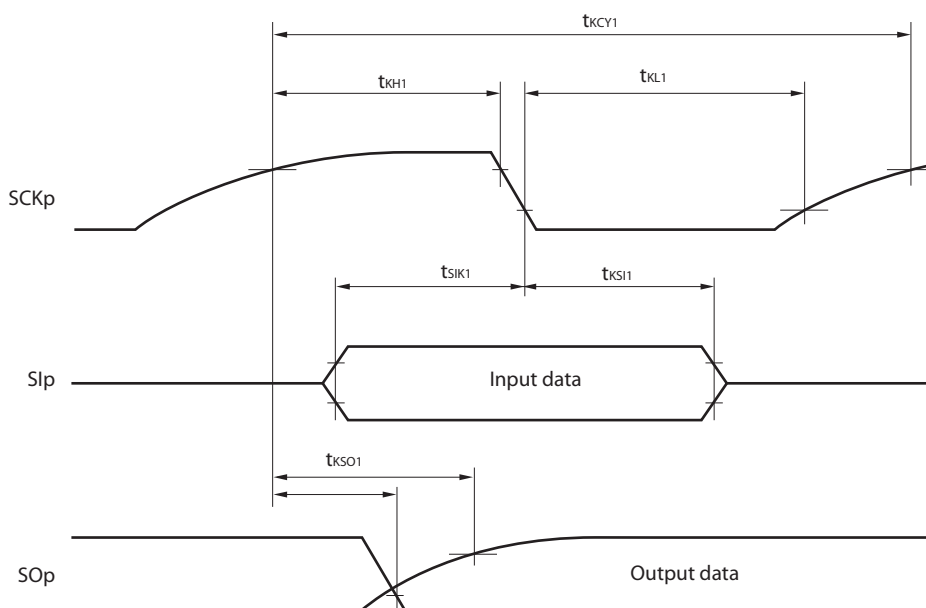
\* This value is the theoretical value of the relative difference between the transmission and reception sides.

- This value as an example is calculated when the conditions described in the “Conditions” column are met. Refer to Note 3 above to calculate the maximum transfer rate under conditions of the customer.

**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1.)**



**CSI mode serial transfer timing (master mode) (during communication at different potential)**  
**(When DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.)**



- Remarks**
1. p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number (m = 00, 01, 02, 10, 12, 13), n: Channel number (n = 0, 2), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)
  2. CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.

**Notes** 1. Excludes quantization error ( $\pm 1/2$  LSB).

2. This value is indicated as a ratio (%FSR) to the full-scale value.

3. When  $AV_{REFP} < V_{DD}$ , the MAX. values are as follows.

Overall error: Add  $\pm 1.0$  LSB to the MAX. value when  $AV_{REFP} = V_{DD}$ .

Zero-scale error/Full-scale error: Add  $\pm 0.05\%$ FSR to the MAX. value when  $AV_{REFP} = V_{DD}$ .

Integral linearity error/ Differential linearity error: Add  $\pm 0.5$  LSB to the MAX. value when  $AV_{REFP} = V_{DD}$ .

4. Refer to **3.6.2 Temperature sensor/internal reference voltage characteristics**.

## 3.6.5 Power supply voltage rising slope characteristics

 $(T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{SS} = 0$  V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Power supply voltage rising slope	$S_{VDD}$				54	V/ms

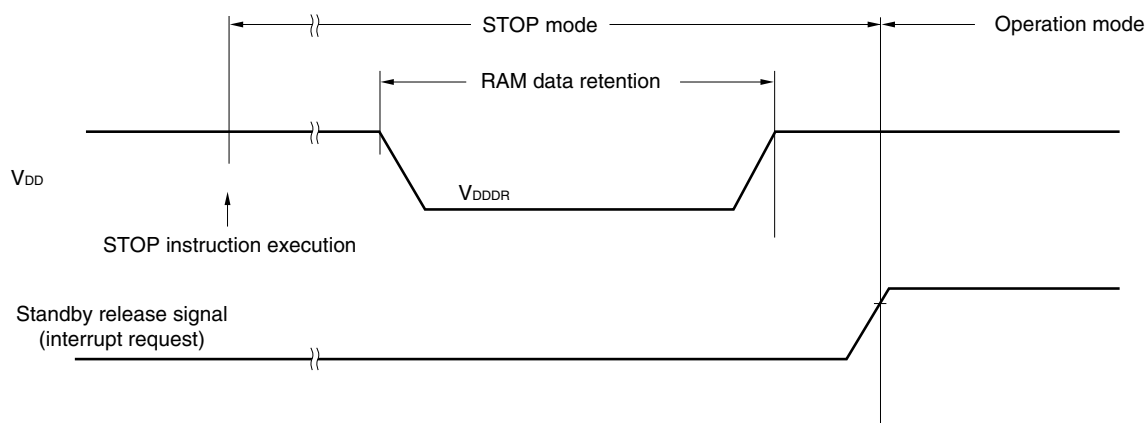
**Caution** Make sure to keep the internal reset state by the LVD circuit or an external reset until  $V_{DD}$  reaches the operating voltage range shown in 3.4 AC Characteristics.

## 3.7 RAM Data Retention Characteristics

 $(T_A = -40$  to  $+105^\circ\text{C}$ ,  $V_{SS} = 0$  V)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Data retention supply voltage	$V_{DDDR}$		1.44 <sup>Note</sup>		5.5	V

**Note** This depends on the POR detection voltage. For a falling voltage, data in RAM are retained until the voltage reaches the level that triggers a POR reset but not once it reaches the level at which a POR reset is generated.



## 4.2 24-pin Products

R5F1007AANA, R5F1007CANA, R5F1007DANA, R5F1007EANA  
 R5F1017AANA, R5F1017CANA, R5F1017DANA, R5F1017EANA  
 R5F1007ADNA, R5F1007CDNA, R5F1007DDNA, R5F1007EDNA  
 R5F1017ADNA, R5F1017CDNA, R5F1017DDNA, R5F1017EDNA  
 R5F1007AGNA, R5F1007CGNA, R5F1007DGNA, R5F1007EGNA

JEITA Package code	RENESAS code	Previous code	MASS(TYP.)[g]
P-HWQFN24-4x4-0.50	PWQN0024KE-A	P24K8-50-CAB-3	0.04

